

C1206C751JATACTU

Aliases (C1206C751JATAC7800) SMD Comm X8G HT150C, Ceramic, 750 pF, 5%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1206, 1.5 mm



Click here for the 3D model.

4000

General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	15 mg	
Shelf Life	78 Weeks	
MSL	1	

30 ppm/C, 1MegaHz 1.0Vrms

0% Loss/Decade Hour: Referee

0.1% 1 MHz 1.0Vrms

Time is 1000 Hours

100 GOhms

		Specifications	
	1206	Capacitance	750 pF
	3.2mm +/-0.2mm	Measurement Condition	1 MHz 1.0Vrms
	1.6mm +/-0.2mm	Tolerance	5%
	0.78mm +/-0.10mm	Voltage DC	250 VDC
	1.5mm MIN	Dielectric Withstanding Voltage	625 VDC
	0.5mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
ations		Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1Me
	T&R, 180mm, Plastic Tape		

Dissipation Factor

Insulation Resistance

Aging Rate

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions

Packaging Specifica

Packaging Quantity

Packaging

Chip Size

L W

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